

## Excellent Integrated System Limited

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[CEL \(California Eastern Laboratories\)](#)  
[PS7342-1A](#)

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**Solid State Relay  
OCMOS FET**

# PS7342-1A, PS7342L-1A

**6-PIN DIP, HIGH ISOLATION VOLTAGE  
400 V BREAK DOWN VOLTAGE  
NORMALLY OPEN TYPE  
1-ch Optical Coupled MOS FET**

—NEPOC Series—

## DESCRIPTION

The PS7342-1A and PS7342L-1A are solid state relays containing GaAs LEDs on the light emitting side (input side) and MOS FETs on the output side.

They are suitable for analog signal control because of their low offset and high linearity.

The PS7342L-1A has a surface mount type lead.

## FEATURES

- High isolation voltage ( $BV = 3\,750\text{ V r.m.s.}$ )
- 1 channel type (1 a output)
- Low LED Operating Current ( $I_F = 2\text{ mA}$ )
- Designed for AC/DC switching line changer
- Small package (6-pin DIP)
- Low offset voltage
- Ordering number of taping product : PS7342L-1A-E3, E4: 1 000 pcs/reel
- Pb-Free product
- Safety standards
  - UL approved: File No. E72422
  - BSI approved: No. 8252/8253
  - CSA approved: No. CA 101391
  - SEMKO approved: No. 606398
  - DEMKO approved: No. 309836
  - NEMKO approved: No. P00100964
  - FIMKO approved: No. FI 15188
  - DIN EN60747-5-2 (VDE0884 Part2) approved (Option)

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## APPLICATIONS

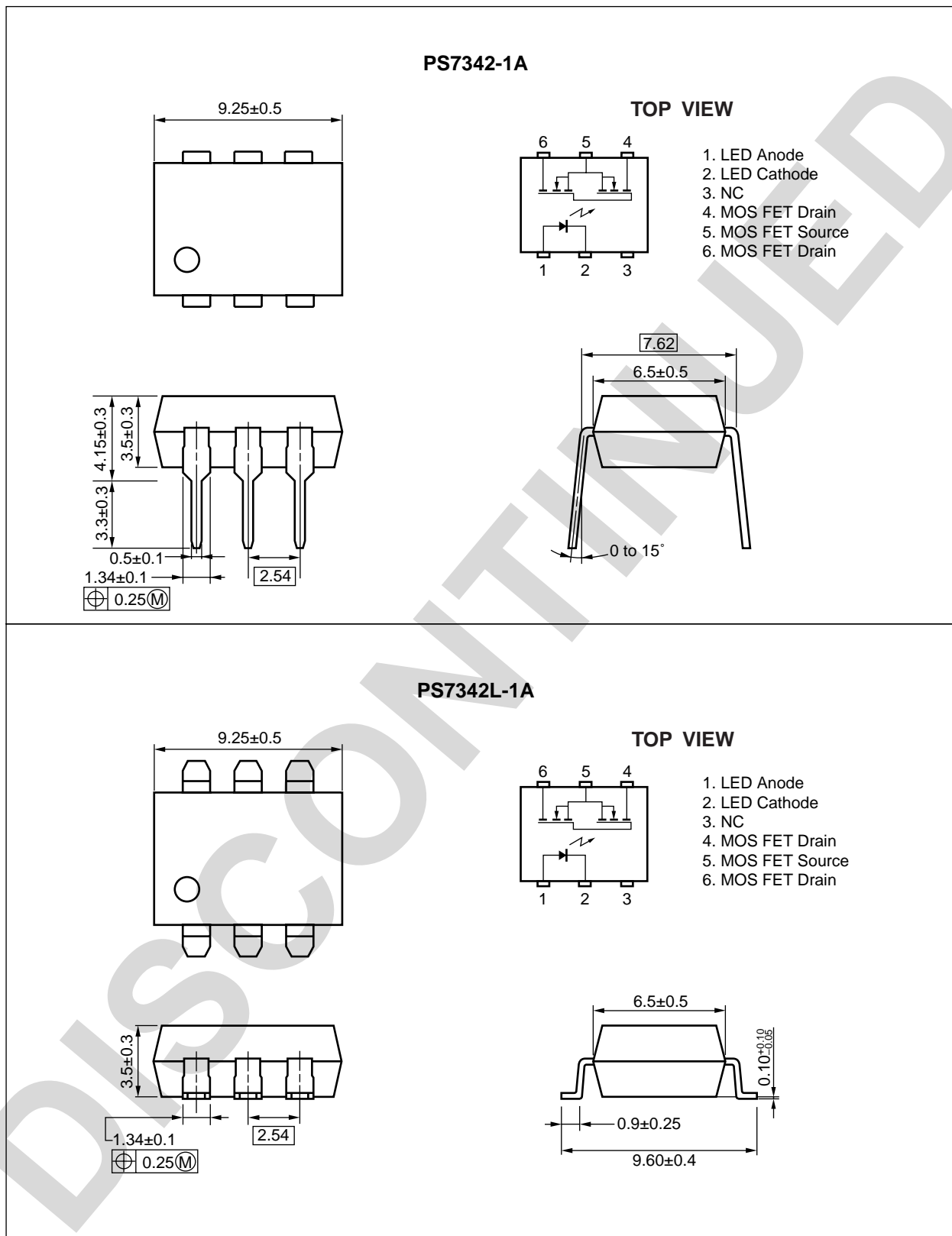
- Exchange equipment
- Measurement equipment
- FA/OA equipment

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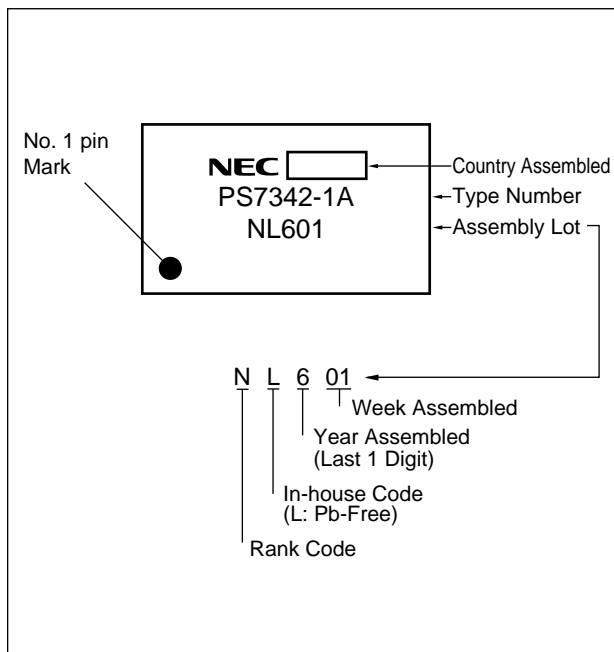
**PS7342-1A, PS7342L-1A**

**PACKAGE DIMENSIONS (in millimeters)**



**PS7342L-1A**

<R> **MARKING EXAMPLE**



<R> **ORDERING INFORMATION**

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number <sup>*1</sup>
PS7342-1A	PS7342-1A-A	Pb-Free	Magazine case 50 pcs	Standard products	PS7342-1A
PS7342L-1A	PS7342L-1A-A			(UL, BSI, CSA, SEMKO,	
PS7342L-1A-E3	PS7342L-1A-E3-A		Embossed Tape 1 000 pcs/reel	DEMKO, NEMKO,	
PS7342L-1A-E4	PS7342L-1A-E4-A			FIMKO approved)	

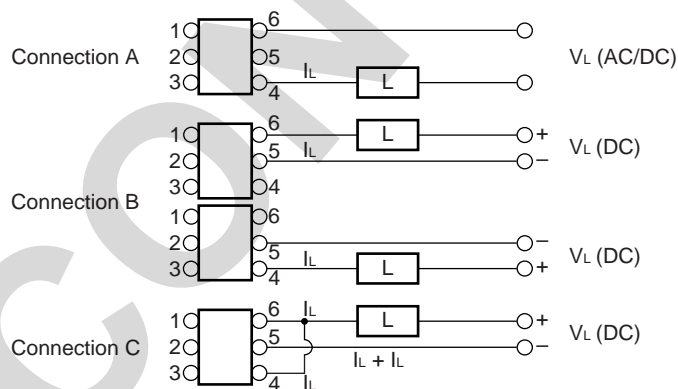
\*1 For the application of the Safety Standard, following part number should be used.

**ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ , unless otherwise specified)**

Parameter		Symbol	Ratings	Unit
Diode	Forward Current (DC)	$I_F$	50	mA
	Reverse Voltage	$V_R$	5.0	V
	Power Dissipation	$P_D$	50	mW
	Peak Forward Current <sup>*1</sup>	$I_{FP}$	1	A
MOS FET	Break Down Voltage	$V_L$	400	V
	Continuous Load Current <sup>*2</sup>	Connection A	200	mA
		Connection B	250	
		Connection C	400	
	Pulse Load Current <sup>*3</sup> (AC/DC Connection)	$I_{LP}$	400	mA
	Power Dissipation	$P_D$	560	mW
Isolation Voltage <sup>*4</sup>		BV	3 750	Vr.m.s.
Total Power Dissipation		$P_T$	610	mW
Operating Ambient Temperature		$T_A$	-40 to +85	$^\circ\text{C}$
Storage Temperature		$T_{stg}$	-40 to +125	$^\circ\text{C}$

<sup>\*1</sup> PW = 100  $\mu\text{s}$ , Duty Cycle = 1%

<sup>\*2</sup> Conditions:  $I_F \geq 2 \text{ mA}$ . The following types of load connections are available.



<sup>\*3</sup> PW = 100 ms, 1 shot

<sup>\*4</sup> AC voltage for 1 minute at  $T_A = 25^\circ\text{C}$ , RH = 60% between input and output  
Pins 1-3 shorted together, 4-6 shorted together.

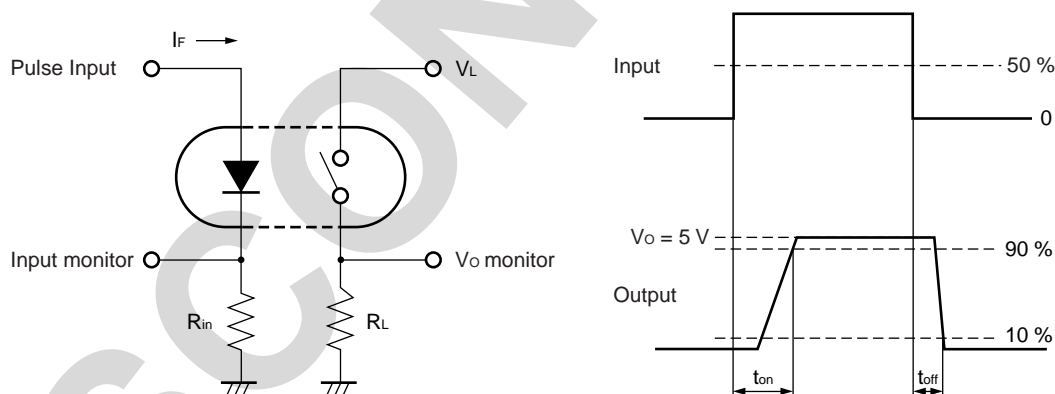
**RECOMMENDED OPERATING CONDITIONS ( $T_A = 25^\circ\text{C}$ )**

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
LED Operating Current	$I_F$	2	10	20	mA
LED Off Voltage	$V_F$	0		0.5	V

**ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ )**

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	$V_F$	$I_F = 10\text{ mA}$		1.2	1.4	V
	Reverse Current	$I_R$	$V_R = 5\text{ V}$			5.0	$\mu\text{A}$
MOS FET	Off-state Leakage Current	$I_{\text{Leak}}$	$V_D = 400\text{ V}$		0.03	1.0	$\mu\text{A}$
	Output Capacitance	$C_{\text{out}}$	$V_D = 0\text{ V}, f = 1\text{ MHz}$		225		pF
Coupled	LED On-state Current	$I_{\text{Fon}}$	$I_L = 200\text{ mA}$			2.0	mA
	On-state Resistance	$R_{\text{on1}}$	$I_F = 10\text{ mA}, I_L = 10\text{ mA}$		6	10	$\Omega$
		$R_{\text{on2}}$	$I_F = 10\text{ mA}, I_L = 200\text{ mA}, t \leq 10\text{ ms}$				
	Turn-on Time <sup>*1, 2</sup>	$t_{\text{on}}$	$I_F = 10\text{ mA}, V_O = 5\text{ V}, R_L = 500\text{ }\Omega,$		1.2	2.5	ms
	Turn-off Time <sup>*1, 2</sup>	$t_{\text{off}}$	$PW \geq 10\text{ ms}$		0.06	0.2	
	Isolation Resistance	$R_{\text{I-O}}$	$V_{\text{I-O}} = 1.0\text{ kV}_{\text{DC}}$	$10^9$			$\Omega$
	Isolation Capacitance	$C_{\text{I-O}}$	$V = 0\text{ V}, f = 1\text{ MHz}$		1.1		pF

**\*1 Test Circuit for Switching Time**



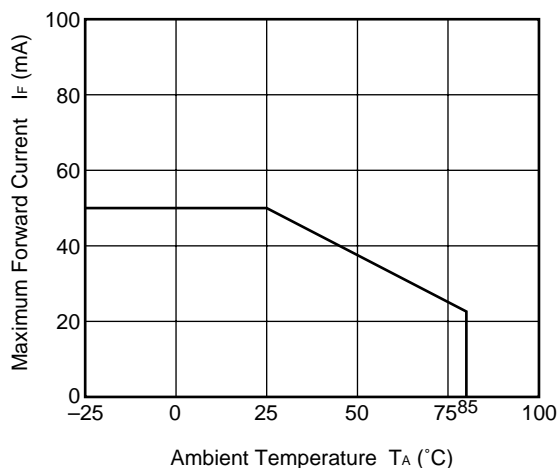
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**\*2** The turn-on time and turn-off time are specified as input-pulse width  $\geq 10\text{ ms}$ .

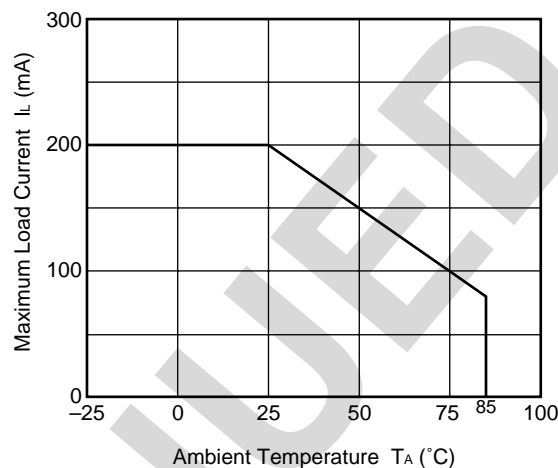
Be aware that when the device operates with an input-pulse width less than 10 ms, the turn-on time and turn-off time will increase.

**TYPICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ , unless otherwise specified)**

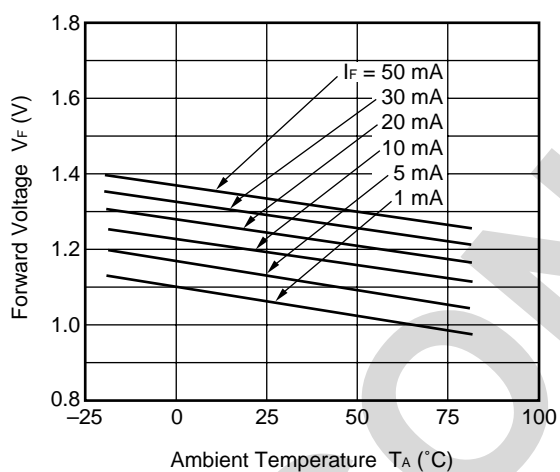
**MAXIMUM FORWARD CURRENT vs. AMBIENT TEMPERATURE**



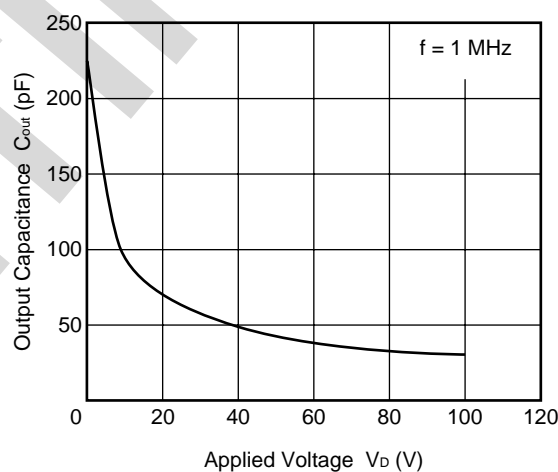
**MAXIMUM LOAD CURRENT vs. AMBIENT TEMPERATURE**



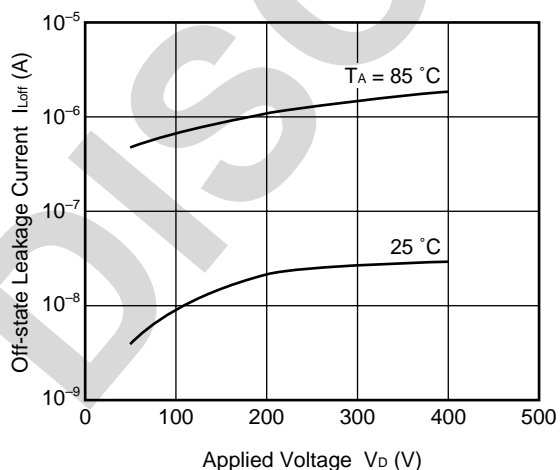
**FORWARD VOLTAGE vs. AMBIENT TEMPERATURE**



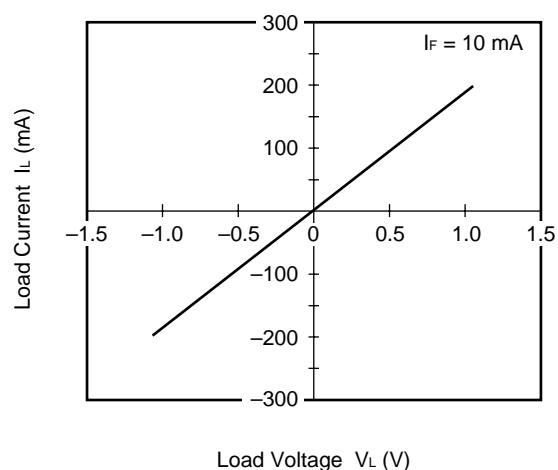
**OUTPUT CAPACITANCE vs. APPLIED VOLTAGE**



**OFF-STATE LEAKAGE CURRENT vs. APPLIED VOLTAGE**



**LOAD CURRENT vs. LOAD VOLTAGE**



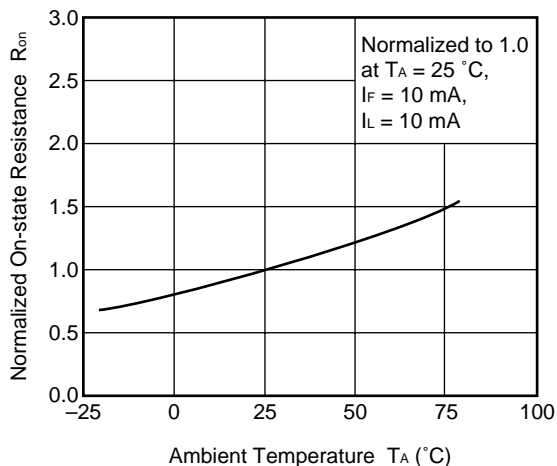
**Remark** The graphs indicate nominal characteristics.



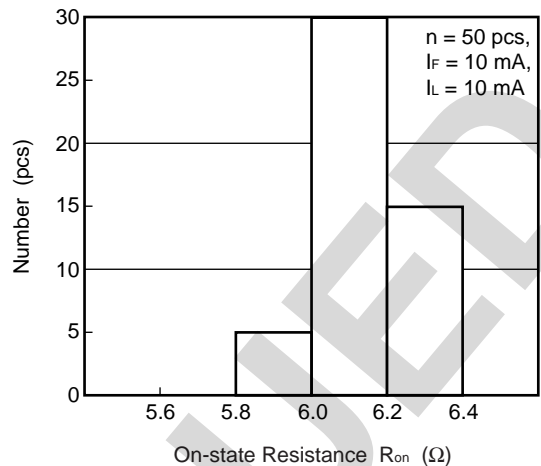
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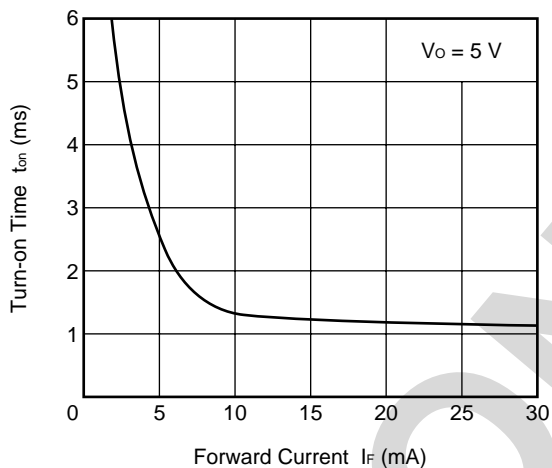
**NORMALIZED ON-STATE RESISTANCE vs. AMBIENT TEMPERATURE**



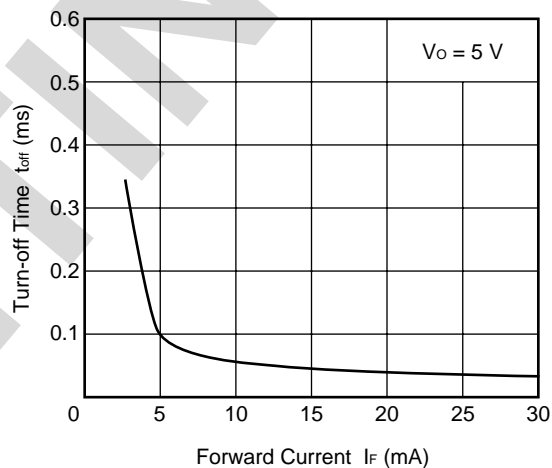
**ON-STATE RESISTANCE DISTRIBUTION**



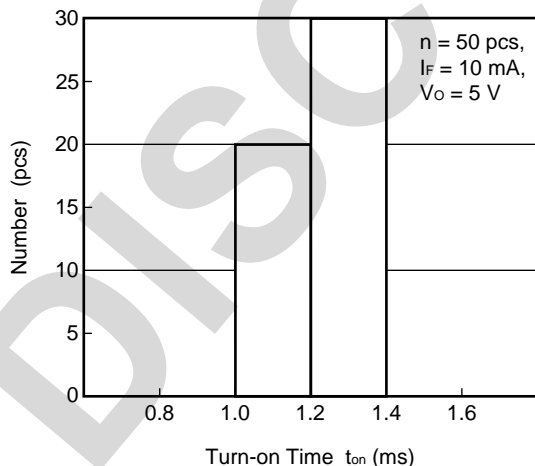
**TURN-ON TIME vs. FORWARD CURRENT**



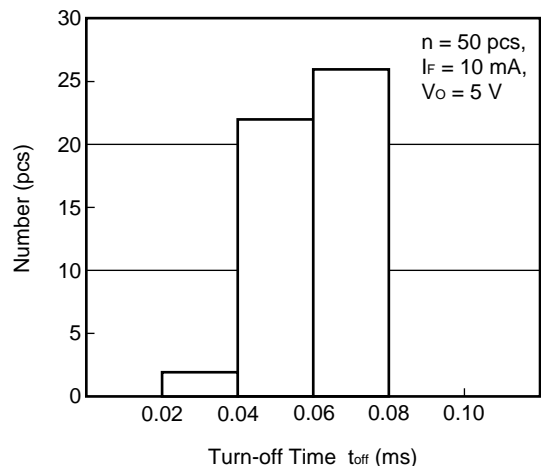
**TURN-OFF TIME vs. FORWARD CURRENT**



**TURN-ON TIME DISTRIBUTION**

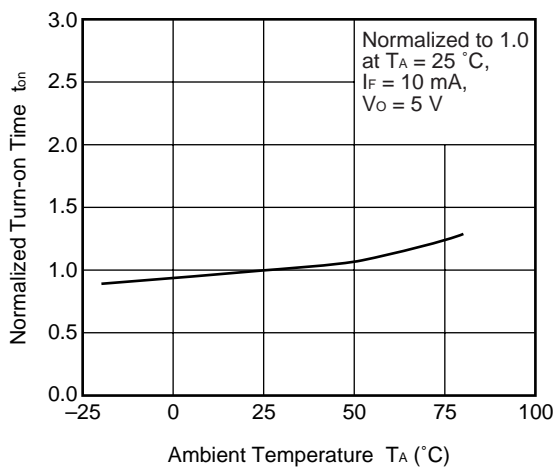


**TURN-OFF TIME DISTRIBUTION**

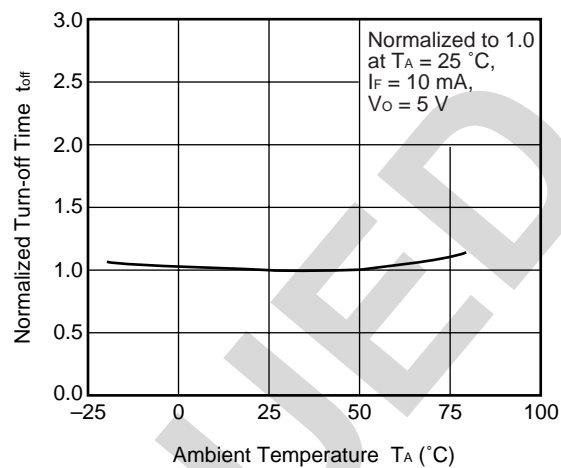


**Remark** The graphs indicate nominal characteristics.

**NORMALIZED TURN-ON TIME vs. AMBIENT TEMPERATURE**



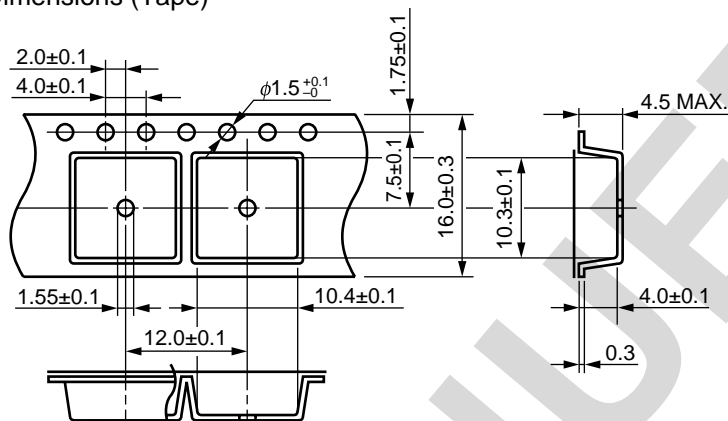
**NORMALIZED TURN-OFF TIME vs. AMBIENT TEMPERATURE**



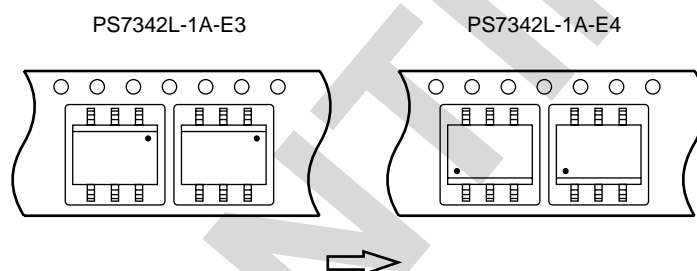
**Remark** The graphs indicate nominal characteristics.

**TAPING SPECIFICATIONS (in millimeters)**

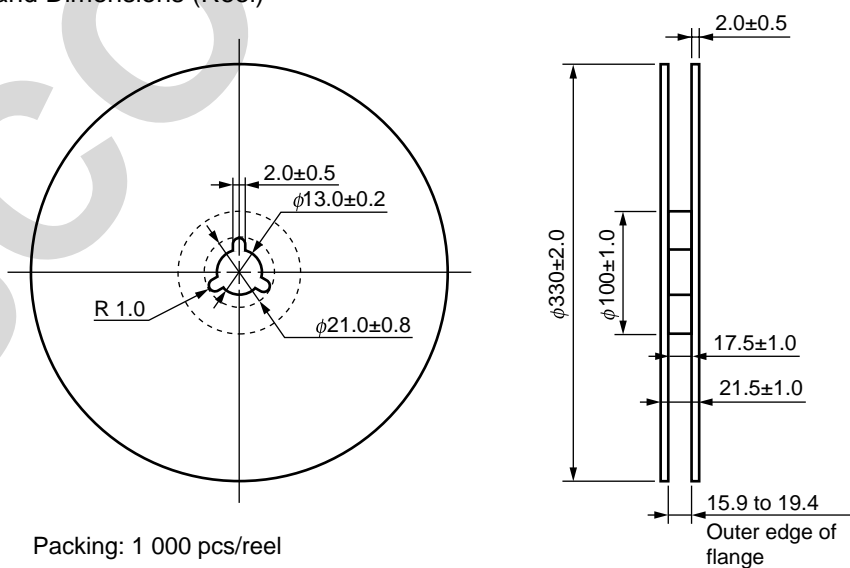
**Outline and Dimensions (Tape)**



**Tape Direction**



**Outline and Dimensions (Reel)**



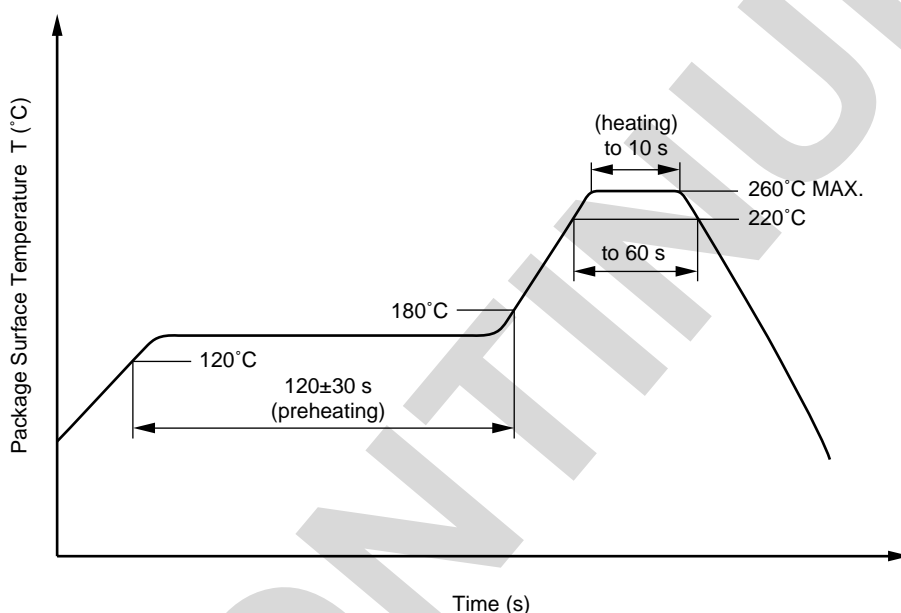
Packing: 1 000 pcs/reel

## RECOMMENDED SOLDERING CONDITIONS

### (1) Infrared reflow soldering

- Peak reflow temperature 260°C or below (package surface temperature)
- Time of peak reflow temperature 10 seconds or less
- Time of temperature higher than 220°C 60 seconds or less
- Time to preheat temperature from 120 to 180°C 120±30 s
- Number of reflows Two
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



### (2) Wave soldering

- Temperature 260°C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times One
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

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### (3) Soldering by soldering iron

- Peak temperature (lead part temperature) 350°C or below
- Time (each pins) 3 seconds or less
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.

(b) Please be sure that the temperature of the package would not be heated over 100°C.

**(4) Cautions**

- <R>
- To avoid quality degradation, assembling within 1 month after take this device out from covered pack is required.  
(Storage conditions 25°C, 65%RH MAX.)
  - Fluxes  
Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

<R> **USAGE CAUTIONS**

1. Protect against static electricity when handling.
2. Avoid storage at a high temperature and high humidity.

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► For further information, please contact

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